

FDS9953A

Dual 30V P-Channel PowerTrench MOSFET

General Description

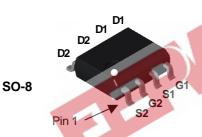
This PChannel MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications requiring a wide range of gave drive voltage ratings (4.5V-25V).

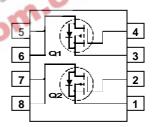
Applications

- Power management
- Load switch
- Battery protection

Features

- $\begin{array}{ll} \bullet & -2.9 \; A, \, -30 \; V & & R_{DS(ON)} = 130 \; m\Omega \; @ \; V_{GS} = -10 \; V \\ & & R_{DS(ON)} = 200 \; m\Omega \; @ \; V_{GS} = -4.5 \; V \\ \end{array}$
- Low gate charge (2.5nC typical)
- · Fast switching speed
- High performance trench technology for extremely low R_{DS(ON)}
- High power and current handling capability





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-30	V
V _{GSS}	Gate-Source Voltage		±25	V
I _D	Drain Current - Continuous	(Note 1a)	±2.9	Α
	- Pulsed		±10	
P _D	Power Dissipation for Dual Operation		2	W
	Power Dissipation for Single Operation	(Note 1a)	1.6	
		(Note 1b)	1	
		(Note 1c)	0.9	
T_J , T_{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
R _{θJC}	Thermal Resistance, Junction-to-Case	(Note 1)	40	°C/W

Package Marking and Ordering Information

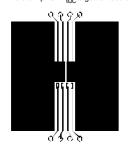
Device Marking	Device	Reel Size	Tape width	Quantity
FDS9953A	FDS9953A	13"	12mm	2500 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-30			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = -250 \mu\text{A}$, Referenced to 25°C		-23		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}$			-2	μΑ
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = -25 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	$V_{GS} = 25 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1	-1.8	-3.0	V
$\Delta V_{GS(th)} \over \Delta T_J$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \mu A$, Referenced to 25°C		4		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$\begin{split} &V_{\text{CS}} = -10 \text{ V}, l_{\text{D}} = -1 \text{ A} \\ &V_{\text{CS}} = -10 \text{ V}, l_{\text{D}} = -1 \text{ A}, T_{\text{J}} = 125^{\circ}\text{C} \\ &V_{\text{CS}} = -4.5 \text{ V}, l_{\text{D}} = -0.5 \text{ A} \\ &V_{\text{CS}} = -4.5 \text{ V}, l_{\text{D}} = -0.5 \text{ A}, T_{\text{J}} = 125^{\circ}\text{C} \\ &V_{\text{CS}} = -10 \text{ V}, &V_{\text{DS}} = -5 \text{ V} \end{split}$		95 137 142 202	130 200 200 310	mΩ
I _{D(on)}	On–State Drain Current	$V_{GS} = -10 \text{ V}, \qquad V_{DS} = -5 \text{ V}$ $V_{GS} = -4.5 \text{ V}, \qquad V_{DS} = -5 \text{ V}$	-5 -1.5			А
g FS	Forward Transconductance	$V_{DS} = -15 \text{ V}, \qquad I_D = -1 \text{ A}$		4		S
Dynamic	Characteristics	Co				
C _{iss}	Input Capacitance	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V},$		185		pF
Coss	Output Capacitance	f = 1.0 MHz		56		pF
C _{rss}	Reverse Transfer Capacitance	1 = 1.0 MHZ		26		pF
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = -15 \text{ V}, \qquad I_D = -1 \text{ A},$		4.5	9	ns
t _r	Turn-On Rise Time	$V_{GS} = -10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		13	23	ns
$t_{d(off)}$	Turn-Off Delay Time			11	20	ns
t _f	Turn-Off Fall Time			2	4	ns
Qg	Total Gate Charge	$V_{DS} = -5 \text{ V}, \qquad I_D = -1 \text{ A},$		2.5	3.5	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -10 \text{ V}$		0.8		nC
Q_{gd}	Gate-Drain Charge			0.9		nC
Drain-Sc	ource Diode Characteristics	and Maximum Ratings				
Is	Maximum Continuous Drain-Source	e Diode Forward Current			-1.2	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = -1.3 \text{ A} \text{(Note 2)}$		-0.8	1.3	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_F = -1.25\text{A},$ $dI_F/dt = 100\text{A/us}$		17	100	nS

Typical Characteristics

Notes:

1. R_{QUA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $\,R_{\theta JC}^{}$ is guaranteed by design while $R_{\theta CA}^{}$ is determined by the user's board design.



78°C/W when mounted on a 0.5in^2 pad of 2 oz copper



125°C/W when mounted on a 0.02 in² pad of 2 oz copper

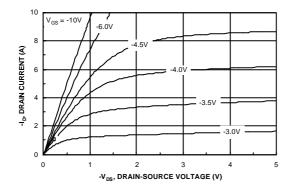


135°C/W when mounted on a minimum pad.

Scale 1:1 on letter size paper

2. Pulse Test: Pulse Width < 300 µs, Duty Cycle < 2.0%

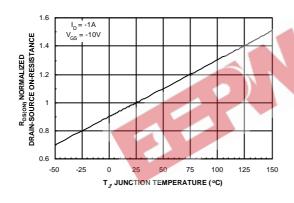
Typical Characteristics



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Figure 1. On-Region Characteristics.





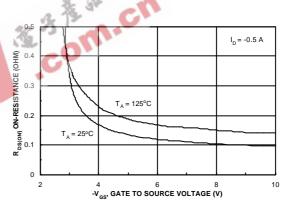
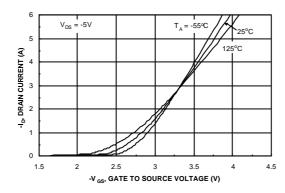


Figure 3. On-Resistance Variation with Temperature.

Figure 4. On-Resistance Variation with Gate-to-Source Voltage.



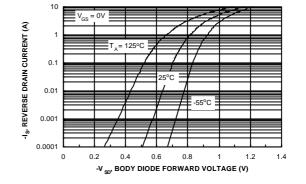
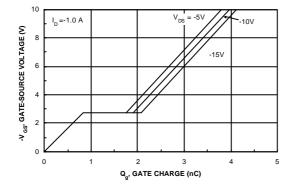


Figure 5. Transfer Characteristics.

Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

Typical Characteristics



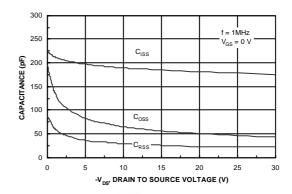


Figure 7. Gate Charge Characteristics.

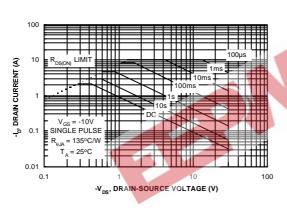


Figure 8. Capacitance Characteristics.

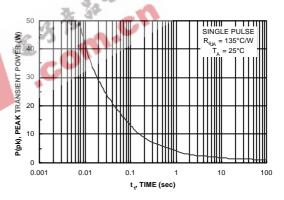


Figure 9. Maximum Safe Operating Area.



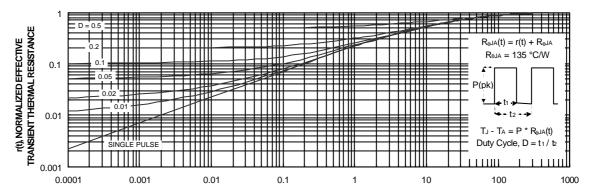


Figure 11. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 1c. Transient thermal response will change depending on the circuit board design.

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